## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of	) Attorney Docket No.: MIYOSH0006
Kazuyoshi TENDOU et al.	) Confirmation No.: 5987
Serial No.: 10/596,387	) Group Art Unit: Unassigned
Filed: June 12, 2006	) Examiner: Unassigned
For: EPOXY RESIN MOLDING MATERIAL FOR SEALING AND ELECTRONIC COMPONENT	) Date: April 13, 2007 )

## SUBMISSION OF MISSING REQUIREMENTS UNDER 35 U.S.C. 371

MAIL STOP: PCT

U.S. Patent and Trademark Office Customer Service Window Randolph Building 401 Dulany Street Alexandria, VA 22314

Sir:

In completing the above-identified application, attached hereto are:

- 1. Credit Card Payment via RAM in the amount of \$130.00; and
- 2. Executed Declaration.

The fees required in this application are calculated as follows:

A. Surcharge (large entity) \$130.00

TOTAL ENCLOSED \$130.00

The Commissioner is hereby requested and authorized to charge any additional fees under 37 CFR 1.16 and 1.17 (except the Issue Fee) which may be required now or hereafter, or credit any overpayment to Deposit Account No. 50-1281 under an Order Number corresponding to the above-noted Attorney Docket Number.

Respectfully submitted,

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